

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
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CORRESPONDENCE DATA																	
<p>Fax Number: (215)689-4905 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 215-979-1250 Email: jsjulianti@duanemorris.com Correspondent Name: Duane Morris LLP Address Line 1: 30 South 17th Street Address Line 4: Philadelphia, PENNSYLVANIA 19103-4196</p>																	
ATTORNEY DOCKET NUMBER:	N1085-00782																

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PATENT
REEL: 026820 FRAME: 0034

NAME OF SUBMITTER:

Steven E. Koffs

Total Attachments: 3

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ATTORNEY DOCKET NO.: 2011.0378/1085.782

ASSIGNMENT AND AGREEMENT

For value received, we, **Ping-Lin YANG, Jun-De JIN, Fu-Lung HSUEH, Sa-Lly LIU, Tong-Chern ONG, Chun-Jung LIN and Ya-Chen KAO**, hereby transfer to **Taiwan Semiconductor Manufacturing Co., Ltd.**, with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **CONTACTLESS COMMUNICATIONS USING FERROMAGNETIC MATERIAL**, described in a non-provisional application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: July 27, 2011


Ping-Lin YANG

Residence:

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Dated: 08/10/2011

Jun-De Jin
Jun-De JIN

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Inventor No. 3

Dated: 8/10/2011


Fu-Lung HSUEH

Residence:

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Inventor No. 4

Dated: 8-1-2011

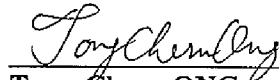

Sa-Lly LIU

Residence:

No. 113, Chih-Ping Road, Apt. 5B, Hsinchu City, Taiwan, R.O.C.

Inventor No. 5

Dated: 8/1/2011

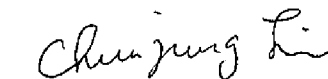

Tong-Chern ONG

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3rd Floor, #2, 86th Lane, Min-Shun Street, Chong-Her City, Taipei County, Taiwan, R.O.C.

Inventor No. 6

Dated: 7/28, 2011

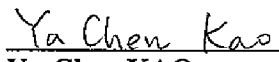

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Inventor No. 7

Dated: 2011.7/27


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Residence:

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